



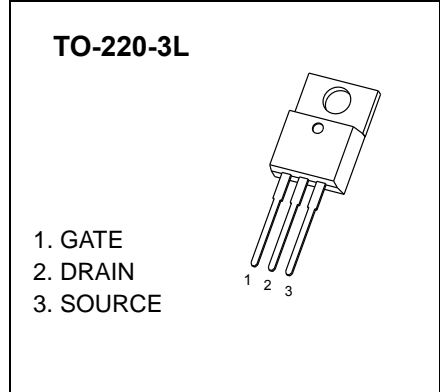
TO-220-3L Plastic-Encapsulate MOSFETS

CJP04N50M1 N-Channel Power MOSFET

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
500V	1.2Ω@10V	4A

GENERAL DESCRIPTION

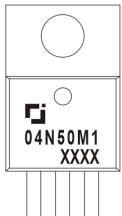
This advanced high voltage MOSFET is designed to stand high energy in the avalanche mode and switch efficiently. This new high energy device also offers a drain-to-source diode fast recovery time. Designed for high voltage, high speed switching applications such as power supplies, converters, power motor controls and bridge circuits.



FEATURE

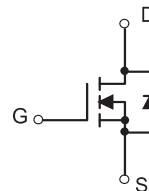
- High Current Rating
- Lower $R_{DS(on)}$
- Lower Capacitance
- Lower Total Gate Charge
- Tighter V_{SD} Specifications
- Avalanche Energy Specified
- Fast Switching Capability

MARKING



04N50M1 = Device code.
 Solid dot = Green molding compound device,
 if none, the normal device
 XXXX=Code

EQUIVALENT CIRCUIT



MAXIMUM RATINGS ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	500	V
Gate-Source Voltage	V_{GS}	±30	V
Continuous Drain Current	I_D ①	4	A
Pulsed Drain Current	I_{DM} ①②	16	A
Single Pulsed Avalanche Energy	E_{AS} ③	315	mJ
Power Dissipation	P_D ①	139	W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$ ⑥	77	°C/W
Thermal Resistance from Junction to Case	$R_{\theta JC}$ ①	0.9	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-55 ~ +150	°C

MOSFET ELECTRICAL CHARACTERISTICS

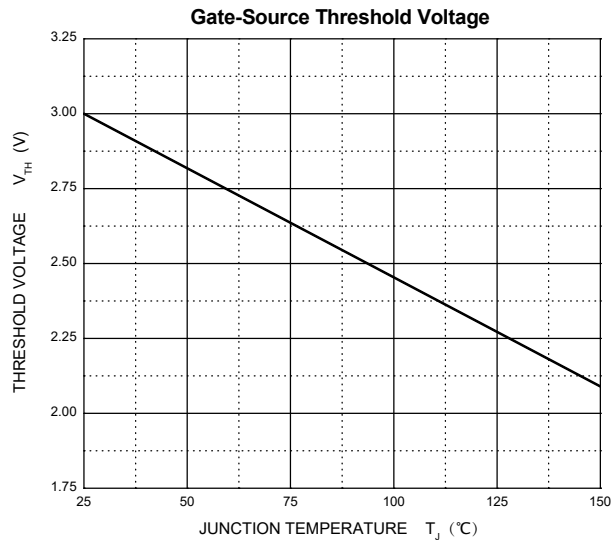
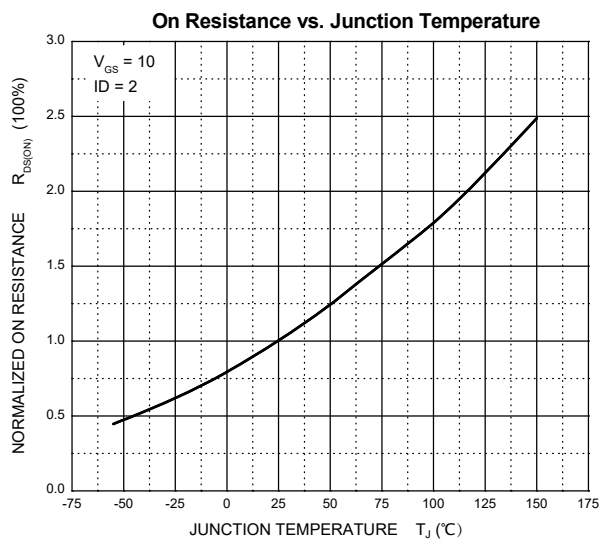
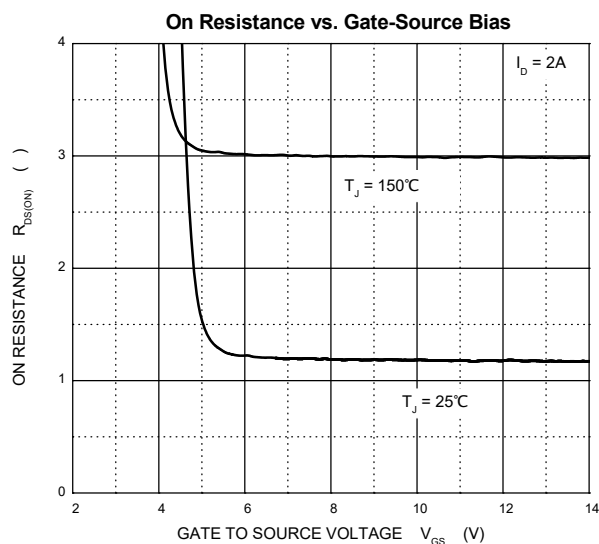
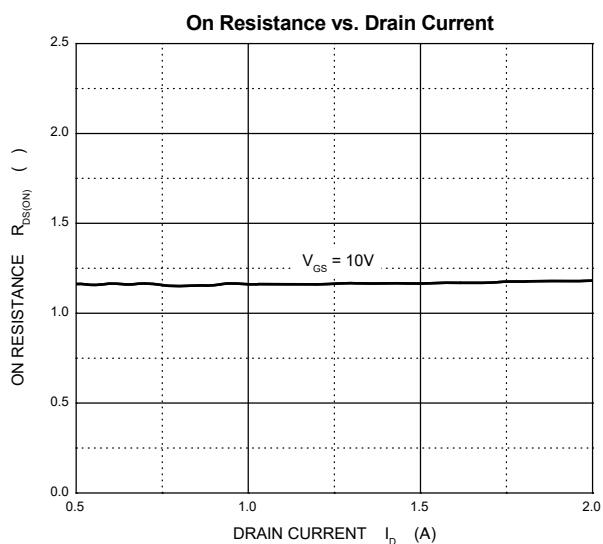
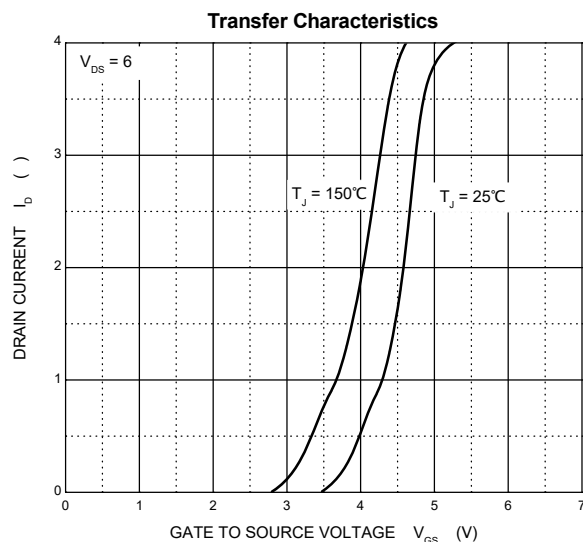
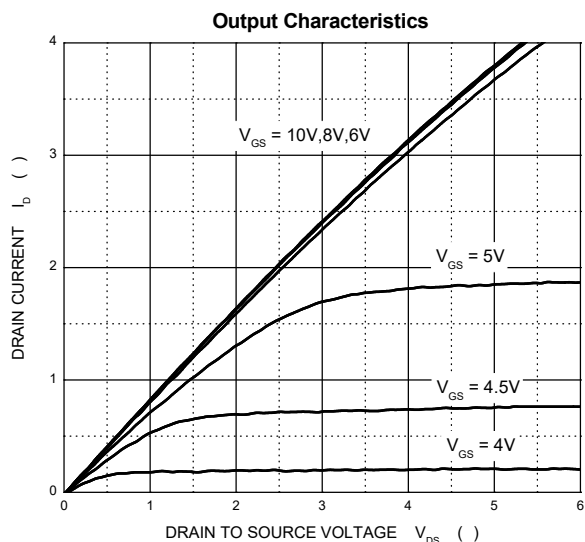
$T_J=25^{\circ}\text{C}$ unless otherwise specified

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit	
Off characteristics							
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 1mA$	500	-	-	V	
Zero gate voltage drain current	I_{DSS}	$V_{DS}=500V, V_{GS}=0V$	$T_J=25^{\circ}\text{C}$	-	-	1.0	μA
			$T_J=125^{\circ}\text{C}$	-	-	100	
Gate-body leakage current	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 30V$	-	-	± 100	nA	
On characteristics ^④							
Gate-threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	2.0	3.0	4.0	V	
Static drain-source on-resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 2A$	-	1.2	1.5	Ω	
Dynamic characteristics ^⑤							
Input capacitance	C_{iss}	$V_{DS} = 50V, V_{GS} = 0V, f = 1\text{MHz}$	-	639	-	pF	
Output capacitance	C_{oss}		-	41	-		
Reverse transfer capacitance	C_{rss}		-	2	-		
Gate resistance	R_g	$f = 1\text{MHz}$	-	2.8	-	Ω	
Switching characteristics ^⑤							
Total gate charge	Q_g	$V_{DS} = 50V, V_{GS} = 10V, I_D = 4A$	-	10	-	nC	
Gate-source charge	Q_{gs}		-	3	-		
Gate-drain charge	Q_{gd}		-	2	-		
Turn-on delay time	$t_{d(on)}$	$V_{DD}=250V, V_{GS}=10V, R_G=10\Omega, I_D = 10A$	-	7	-	ns	
Turn-on rise time	t_r		-	5	-		
Turn-off delay time	$t_{d(off)}$		-	13	-		
Turn-off fall time	t_f		-	5	-		
Drain-Source Diode Characteristics							
Drain-source diode forward voltage	V_{SD} ^④	$V_{GS} = 0V, I_S = 4A$	-	-	1.2	V	
Maximum continuous drain-source diode forward current	I_S ^①		-	-	4	A	
Maximum pulsed drain-source diode forward current	I_{SM} ^{①②}		-	-	16	A	
Reverse recovery time	t_{rr}	$dI_F/dt = 100A/\mu\text{s}, I_S = 10A, V_{DD} = 50V$	-	196	-	ns	
Reverse recovery charge	Q_{rr}		-	1131	-	nC	

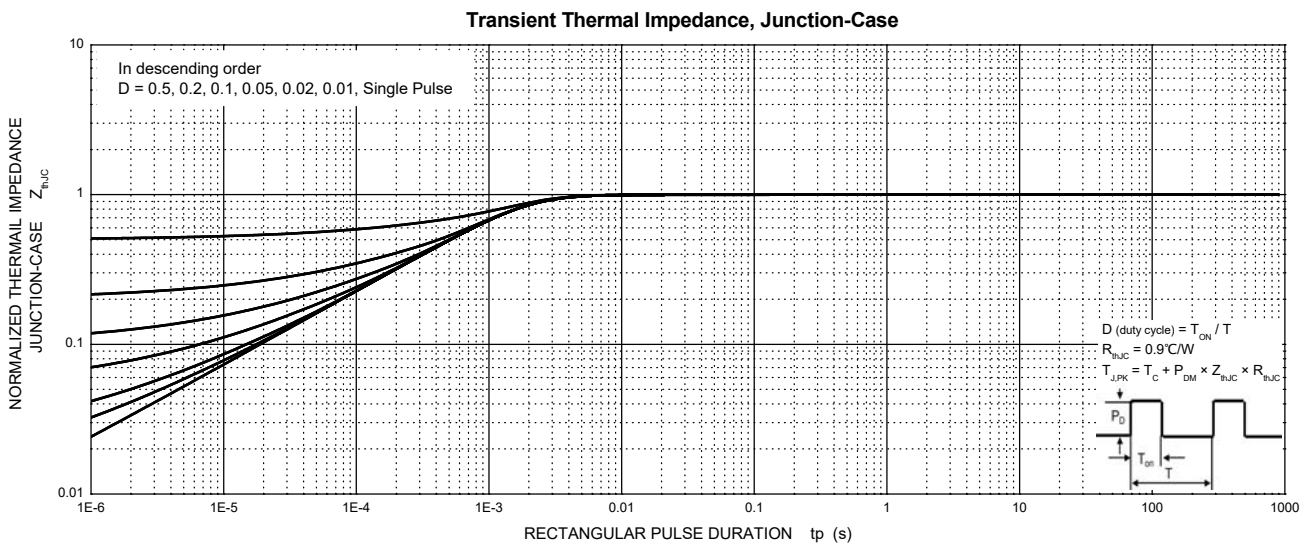
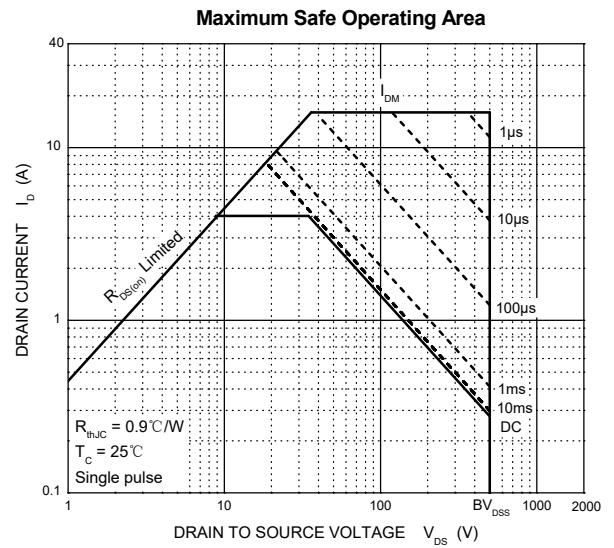
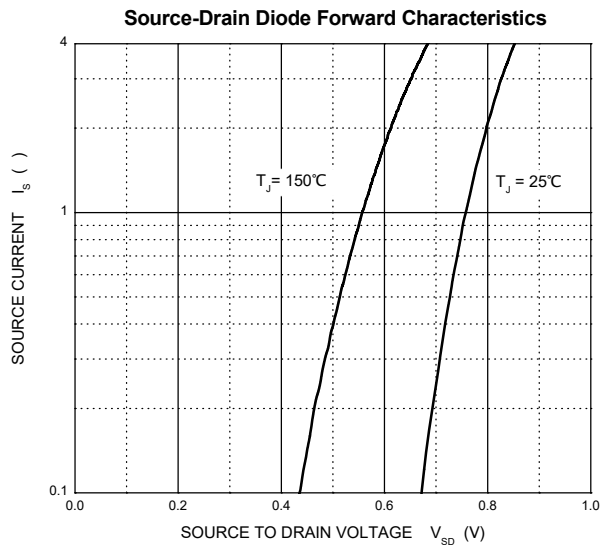
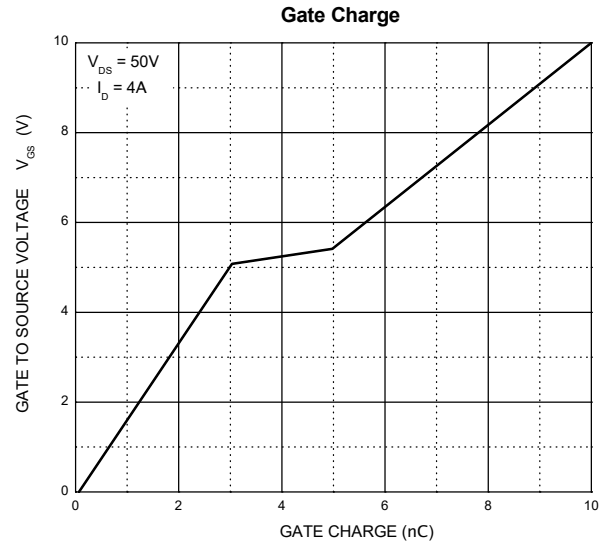
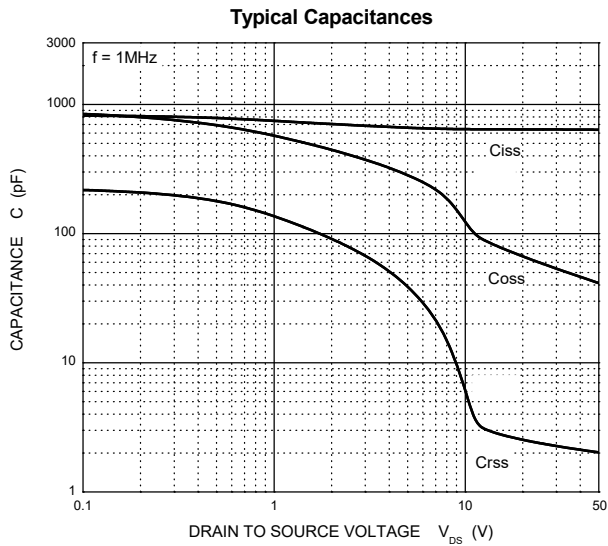
Notes :

- $T_C=25^{\circ}\text{C}$ Limited only by maximum temperature allowed.
- $P_W \leq 10\mu\text{s}$, Duty cycle $\leq 1\%$.
- EAS condition: $V_{DD}=50V, V_{GS}=10V, L=10\text{mH}, R_g=25\Omega$, Starting $T_J = 25^{\circ}\text{C}$.
- Pulse Test : Pulse Width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
- Guaranteed by design, not subject to production.
- The value of $R_{\theta JA}$ is measured with the device in a still air environment with $T_a=25^{\circ}\text{C}$

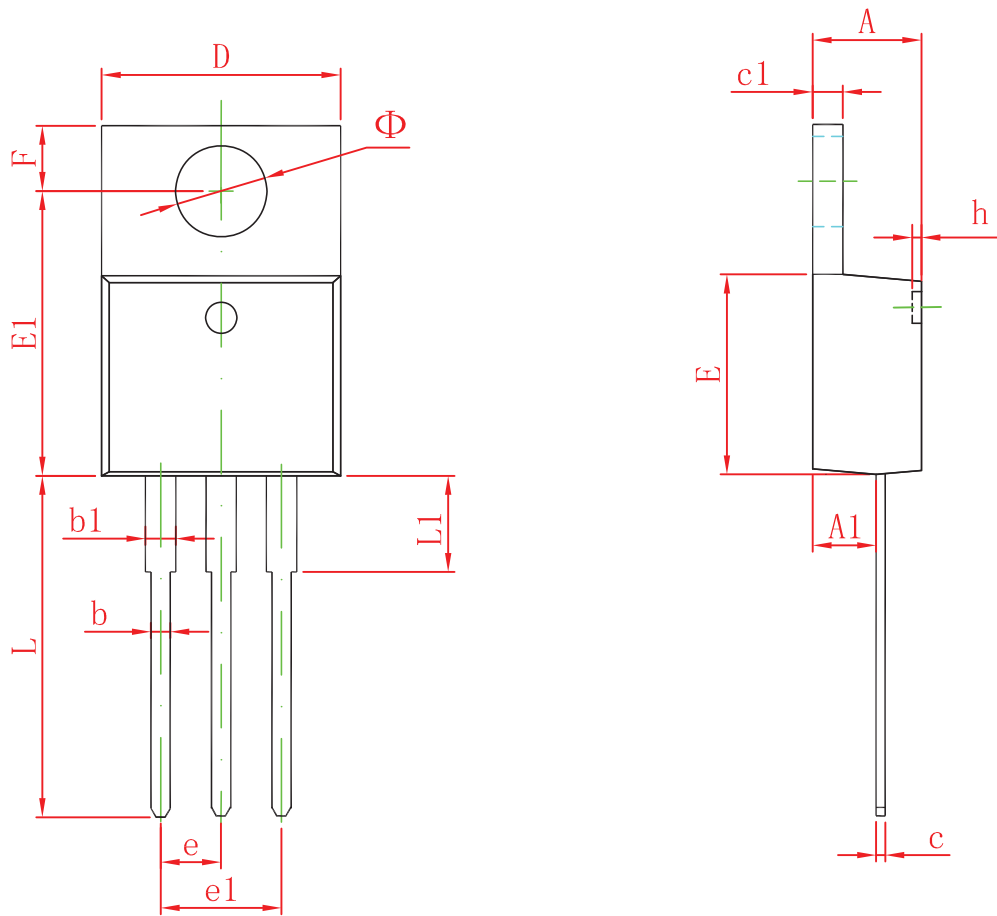
Typical Characteristics ($T_J = 25^\circ\text{C}$, unless otherwise specified)



Typical Characteristics ($T_J = 25^\circ\text{C}$, unless otherwise specified)



TO-220-3L Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	4.450	4.750	0.175	0.187
A1	2.520	2.820	0.099	0.111
b	0.710	0.910	0.028	0.036
b1	1.170	1.370	0.046	0.054
c	0.300	0.500	0.012	0.020
c1	1.170	1.370	0.046	0.054
D	9.830	10.330	0.387	0.407
E	8.500	8.900	0.335	0.350
E1	12.050	12.650	0.474	0.498
e	2.540 TYP		0.100 TYP	
e1	4.900	5.200	0.192	0.205
F	2.540	2.940	0.100	0.116
h	0.100 TYP		0.004 TYP	
L	13.300	13.800	0.523	0.543
L1	3.540	3.940	0.139	0.155
Φ	3.735	3.935	0.147	0.155